



FD6M043N08

75V/65A Synchronous Rectifier Module

March 2008
Power-SPM™

General Features

- Very High Rectification Efficiency at Output 12V
- Integrated Solution for Saving Board Space
- RoHS Compliant



MOSFET Features

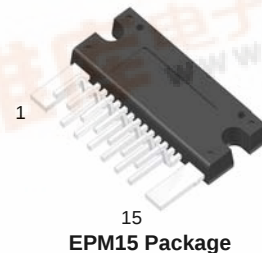
- $V_{DS} = 75V$
- $Q_G(TOTAL) = 99nC(Typ.)$, $V_{GS} = 10V$
- $R_{DS(ON)} = 3.5m\Omega(Typ.)$, $V_{GS} = 10V$, $I_D = 40A$
- Low Miller Charge
- Low Q_{rr} Body Diode
- UIS Capability (Single Pulse and Repetitive Pulse)
- Fully Isolated Package

General Description

The FD6M043N08 is one product in the Power-SPM™ family that Fairchild has newly developed and designed to be most suitable for more compact and more efficient synchronous rectification applications such as internet server power supplies and telecom system power supplies. For higher efficiency, it includes built-in very low $R_{DS(ON)}$ MOSFETs. This Power-SPM device can be used in the secondary side of the PWM transformer of forward/bridge converter to provide high current rectification at output voltages ranging from 12 Volts down to 5 Volts. With this product, it is possible to design the secondary side of power supply systems with reduced parasitic elements resulting in minimized voltage spike and EMI noise.

Applications

- High Current Isolated Converter
- Distributed Power Architectures
- Synchronous Rectification
- DC/DC Converter
- Battery Supplied Application
- ORing MOSFET



Block Diagram

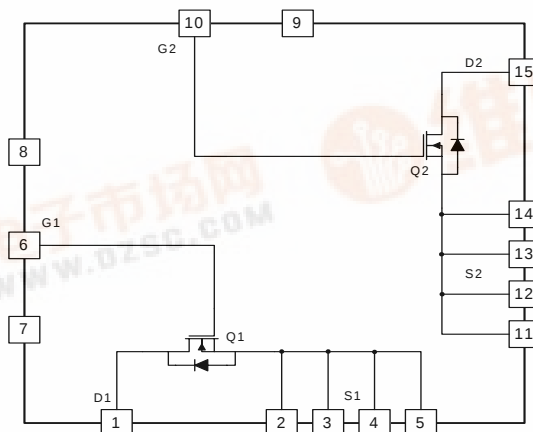


Figure 1. FD6M043N08 Module Block Diagram

Pin Configuration and Pin Description

Top View

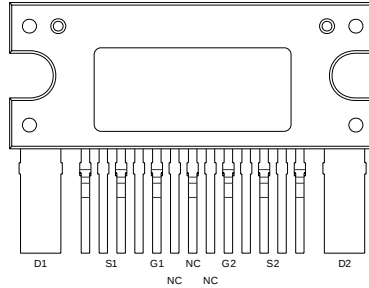


Figure 2. Pinmap of FD6M043N08

Pin Number	Pin Name	Pin Description
1	D1	Drain of Q1, MOSFET
2 ~ 5	S1	Source of Q1, MOSFET
6	G1	Gate of Q1, MOSFET
7	NC	No Connection
8	NC	No Connection
9	NC	No Connection
10	G2	Gate of Q2, MOSFET
11 ~ 14	S2	Source of Q2, MOSFET
15	D2	Drain of Q2, MOSFET

Absolute Maximum Ratings $T_C = 25^\circ\text{C}$, Unless Otherwise Specified

Symbol	Parameter	Rating	Unit
V_{DS}	Drain to Source Voltage (Note1)	75	V
V_{GS}	Gate to Source Voltage	± 20	V
I_D	Drain Current, Continuous ($V_{GS} = 10\text{V}$) (Note1)	65	A
E_{AS}	Single Pulse Avalanche Energy (Note1,2)	681	mJ
T_J, T_{STG}	Operating and Storage Temperature Range	-40 ~ 150	$^\circ\text{C}$

Thermal Resistance

Symbol	Parameter	Min.	Typ.	Max.	Unit
$R_{\theta JC}$	Junction to Case Thermal Resistance (Note1)	-	-	3.9	$^\circ\text{C/W}$

Note:

- Each MOSFET Switch
- Starting $T_J = 25^\circ\text{C}$, $V_D = 40\text{V}$, $L = 0.2\text{mH}$, $I_{AS} = 56.4\text{A}$

Electrical Characteristics $T_C = 25^\circ\text{C}$, Unless Otherwise Specified

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
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Synchronous Rectifier Switch Part (Each Switch)

BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250\mu\text{A}$, $V_{GS} = 0\text{V}$	75	-	-	V
I_{DSS}	Zero Gate Voltage Drain Current	$V_{GS} = 0\text{V}$, $V_{DS} = 60\text{V}$	-	-	1	μA
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 20\text{V}$	-	-	± 100	nA
$V_{GS(TH)}$	Gate Threshold Voltage	$V_D = 20\text{V}$, $I_{DS} = 250\mu\text{A}$	2.0	-	4.0	V
$R_{DS(ON)}$	Drain to Source On Resistance	$I_D = 40\text{A}$, $V_{GS} = 10\text{V}$	-	3.5	4.3	m Ω
		$T_J = 150^\circ\text{C}$	-	6.44	-	

Dynamic Characteristics

C_{ISS}	Input Capacitance	$V_{DS} = 25\text{V}$, $V_{GS} = 0\text{V}$, $f = 1\text{MHz}$	-	6180	-	pF
C_{OSS}	Output Capacitance		-	990	-	pF
C_{RSS}	Reverse Transfer Capacitance		-	310	-	pF
$Q_{g(TOT)}$	Total Gate Charge at 10V	$V_{GS} = 0\text{V}$ to 10V	-	99	148	nC
$Q_{g(TH)}$	Threshold Gate Charge	$V_{GS} = 0\text{V}$ to 2V	-	12	18	nC
Q_{gs}	Gate to Source Gate Charge	$V_{DD} = 40\text{V}$	-	30	-	nC
Q_{gs2}	Gate Charge Threshold to Plateau	$I_D = 80\text{A}$	-	18	-	nC
Q_{gd}	Gate to Drain "Miller" Charge	$I_g = 1.0\text{mA}$	-	25	-	nC

Switching Characteristics ($V_{GS} = 10\text{V}$)

t_{ON}	Turn-On Time	$I_D = 40\text{A}$ $V_{GS} = 10\text{V}$, $V_{DD} = 40\text{V}$, $R_G = 5\Omega$	-	-	90	ns
$t_{d(on)}$	Turn-On Delay Time		-	25	-	ns
t_r	Rise Time		-	25	-	ns
$t_{d(off)}$	Turn-Off Delay Time		-	50	-	ns
t_f	Fall Time		-	26	-	ns
t_{OFF}	Turn-Off Time		-	-	130	ns

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Voltage	$I_{SD} = 80\text{A}$, $V_{GS} = 0\text{V}$	-	-	1.25	V
		$I_{SD} = 40\text{A}$, $V_{GS} = 0\text{V}$	-	-	1.0	
t_{rr}	Reverse Recovery Time	$I_{SD} = 40\text{A}$, $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	42	-	ns
Q_{rr}	Reverse Recovery Charge	$I_{SD} = 40\text{A}$, $dI_{SD}/dt = 100\text{A}/\mu\text{s}$	-	62	-	nC

Typical Performance Characteristics Each Switch, Unless Otherwise Specified

Figure 3. On-Region Characteristics

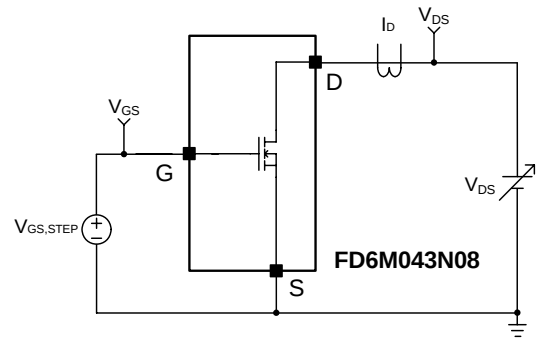
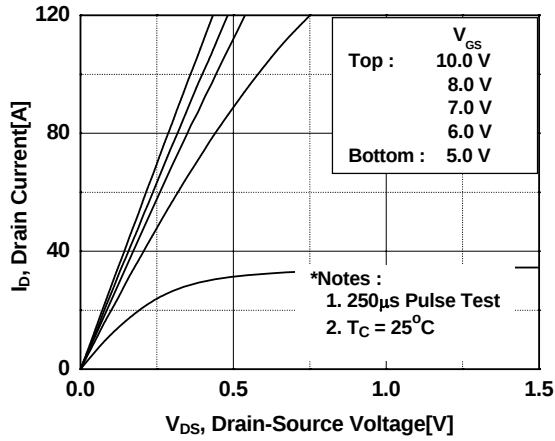


Figure 4. Transfer Characteristics

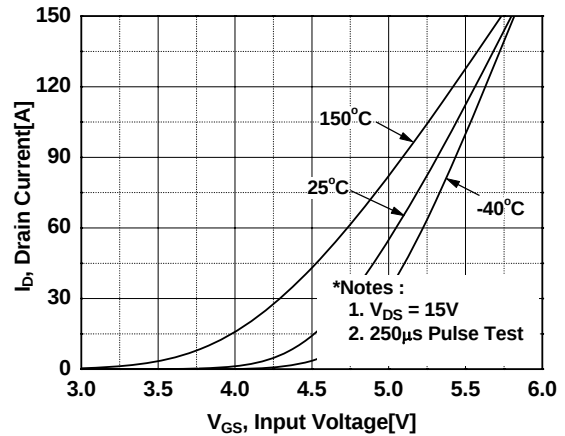
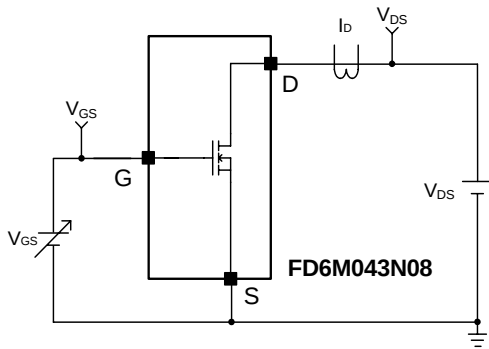


Figure 5. Body Diode Forward Voltage Variation vs. Source Current and Temperature

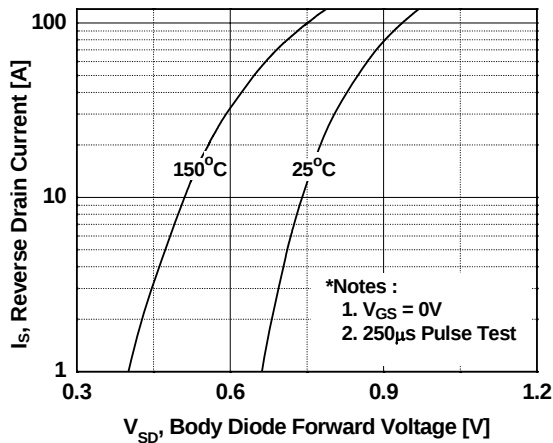
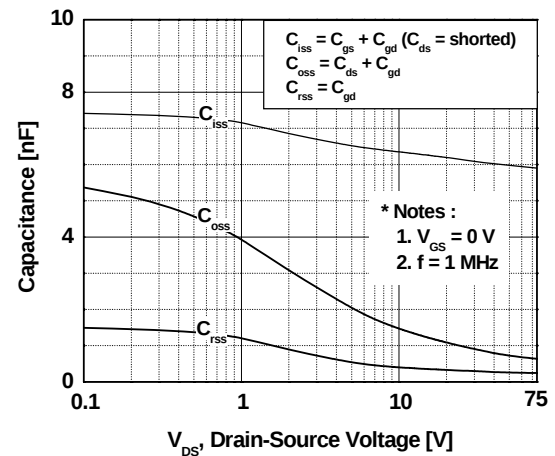


Figure 6. Output Capacitance Characteristics



Typical Performance Characteristics (Continued)

Figure 7. Breakdown Voltage Variation vs. Temperature

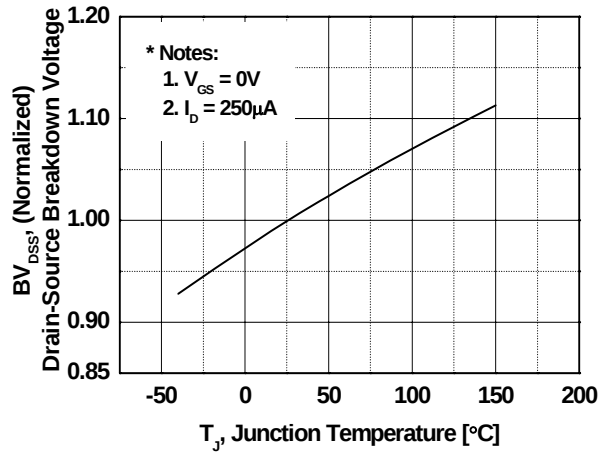


Figure 8. On-Resistance Variation vs. Temperature

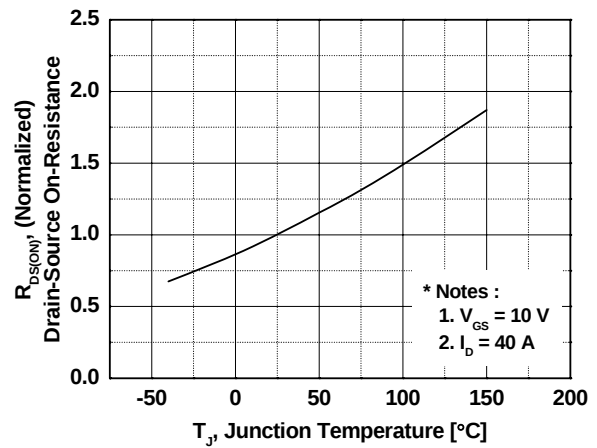


Figure 9. Transient Thermal Response Curve

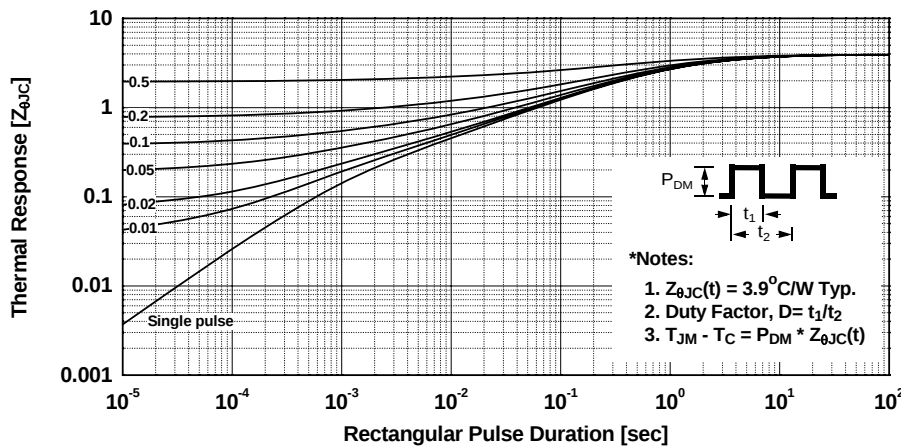


Figure 10. Maximum Safe Operating Area

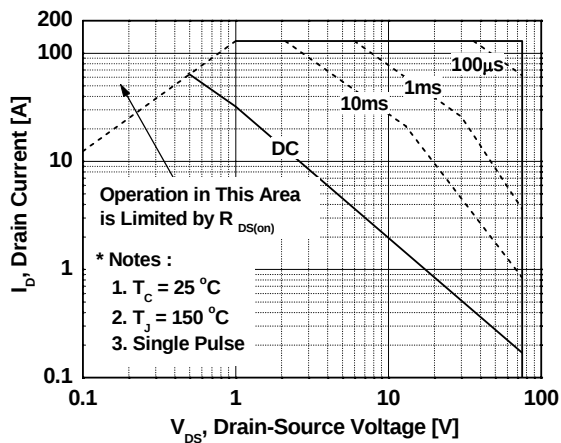
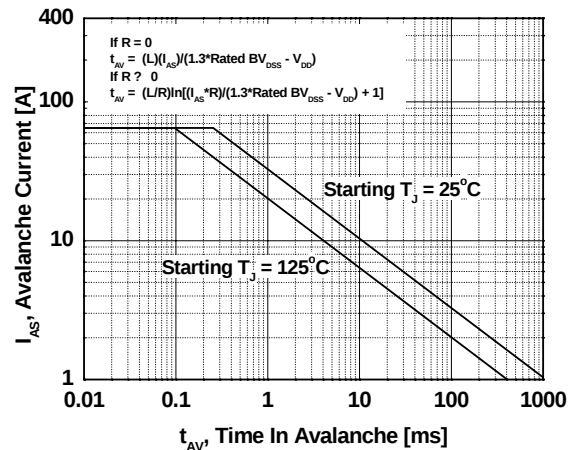


Figure 11. Unclamped Inductive Switching Capability



AC Test Circuits and Waveforms

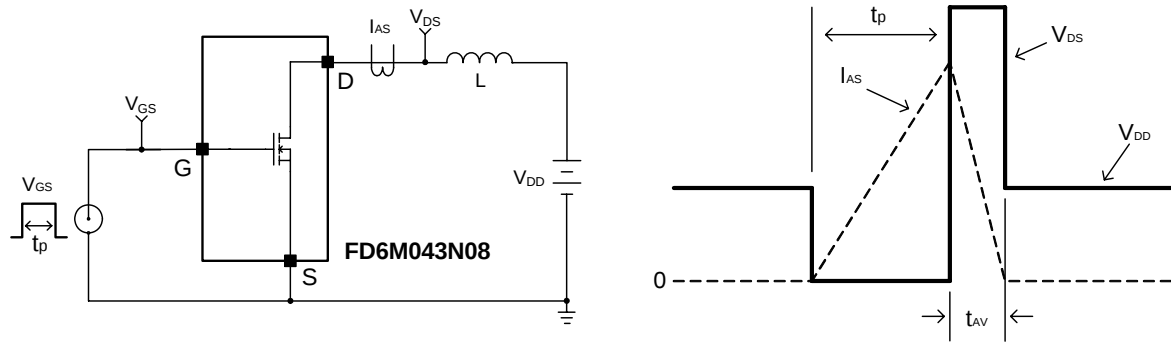


Figure 12. Unclamped Inductive Switching Test Circuit and Waveforms

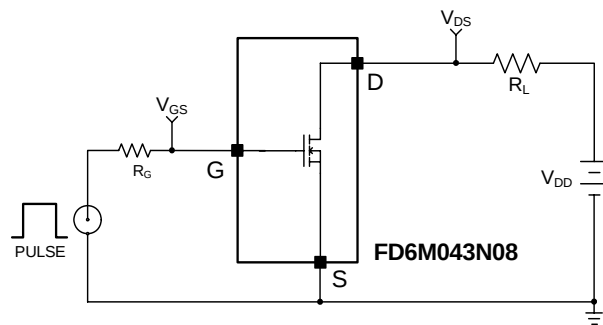


Figure 13. Switching Test Circuit

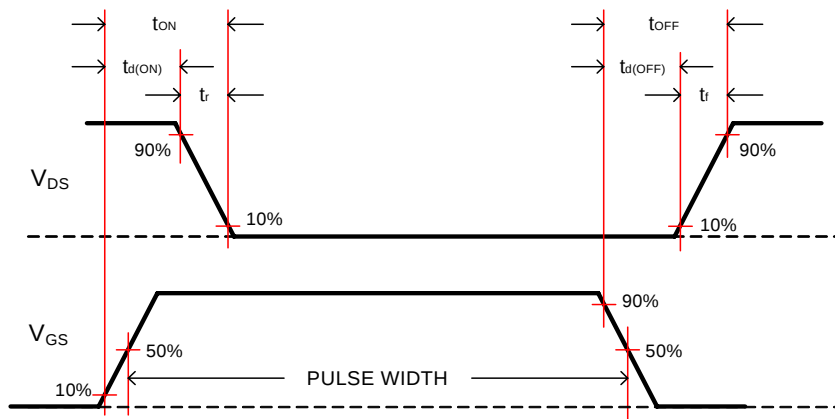


Figure 14. Switching Test Waveforms

Application circuits

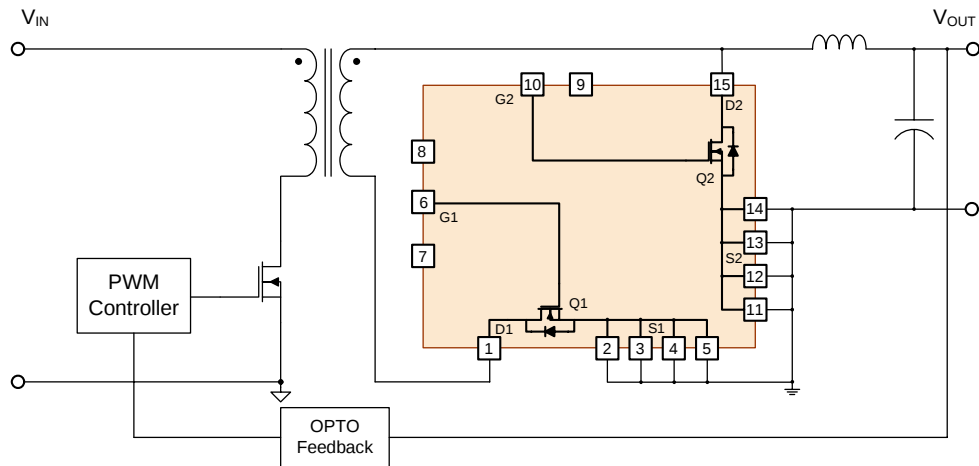


Figure 15. Application Circuit of Forward Converter with FD6M043N08

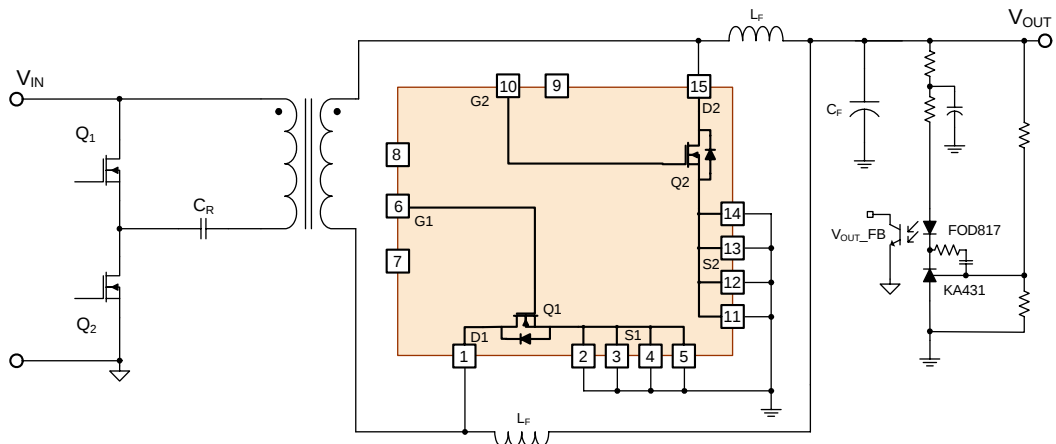


Figure 16. Application Circuit of Asymmetrical HB Converter with FD6M043N08

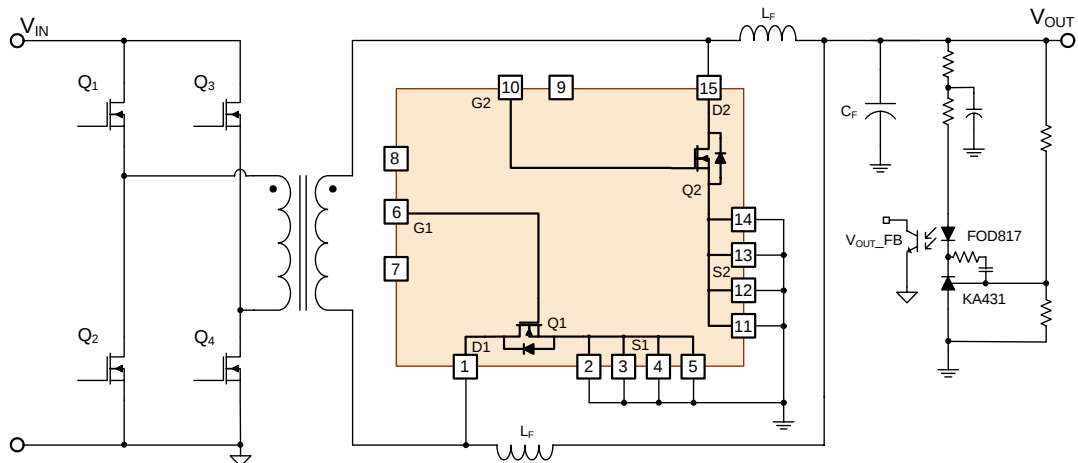


Figure 17. Application Circuit of Full Bridge Converter with FD6M043N08

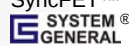


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